

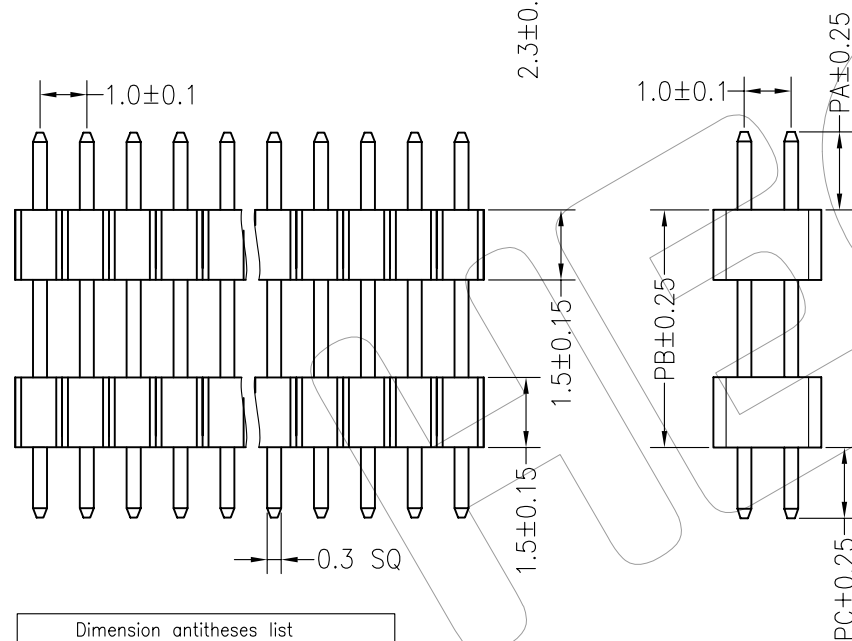
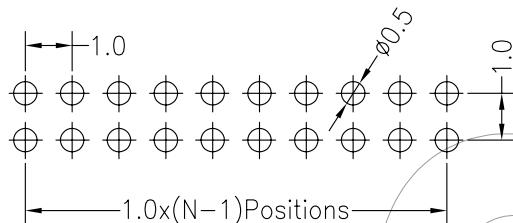
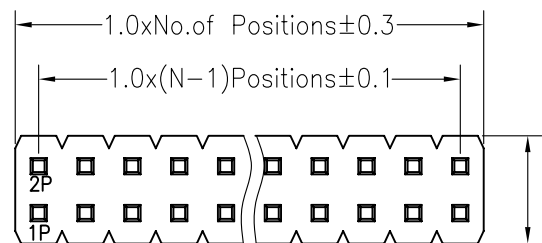
RoHS

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE ± 0.05)

SPECIFICATIONS

Rated Current:0.75AMP
Contact Resistance:30m Ω Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000M Ω Min
Operation Temperature:-40 $^{\circ}$ c to +105 $^{\circ}$ c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V-0)
Standard: PA6T
Max.Processing Temp: 230 $^{\circ}$ C for 30-60 seconds
(260 $^{\circ}$ C for 10 seconds)



Dimension antitheses list				
ITEM	PA	PB	PC	L
Standard	1.80	3.00	1.80	6.60
Alternate				

Ordering Information

HC-PH815 22 XX X S XX N XXX X 01

No.of Pins
Per Row
2x1~2x50

Insulator Material
Option
A=BK-PBT
B=BK-PA66
C=BK-PA6T
D=BK-PA46
F=BK-LCP

Contact Plating
G0:Gold Flash
G1:3U" Gold
G2:5U" Gold
G3:10U" Gold
G4:15U" Gold
G5:30U" Gold
S0:Gold Flash/Tin
SN:Tin

Pin Length

Packing
0=PE Bag
A=Tray
T=Tube
R=Tape & Reel
M=Reel+Mylar

OPERATION

X.X ± 0.30

X.XX ± 0.20

X.XXX ± 0.10

Angle $\pm 3^{\circ}$

DIM TOL

DRAW

Ayang

CHECK

APPROVE

SCALE

FIT

UNIT

mm

SIZE

A4

SHEET

1/1

PROJ.

1/1

HECON 东莞市禾康电子有限公司
DONGGUAN HECON ELECTRONICS CO.,LTD

PART NO.

HC-PH81522XXXSXXNXXX01

TITLE:

1.0mm 2xH1.5 Dual Row 180° Pin Header

A0

REV

DATE

MODIFICATION DESCRIPTION

CHANGE

DIM

TOL

NEW DRAWING